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PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application

APPL NUM 10092525	FILING DATE 03/08/2002	CLASS 257	SUBCLASS	GAU 2681	EXAMINER <i>Gebr...</i>
**APPLICANTS: Okamoto Keishiro; Shioga Takeshi; Taniguchi Osamu; Omote Koji; Imanaka Yoshihiko; Yamagishi Yasuo; <i>281</i>					
**CONTINUING DATA VERIFIED: <i>None</i>					
** FOREIGN APPLICATIONS VERIFIED: JAPAN 2001-329687 10/26/2001 <i>Yes</i>					
PG-PUB <input type="checkbox"/> DO NOT PUBLISH <input type="checkbox"/>		RESCIND <input type="checkbox"/>			
Foreign priority claimed <input type="checkbox"/> yes <input type="checkbox"/> no		35 USC 119 conditions met <input type="checkbox"/> yes <input type="checkbox"/> no		ATTORNEY DOCKET NO 020214	
Verified and Acknowledged Examiners's initials <i>S</i>					
TITLE : Semiconductor system-in-package					

U.S. DEPT. OF COMM/PAT. & TM.-PTO-436L (Rev. 12-94)

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
		Total Claims	Print Claim for O.G.
ISSUE FEE		DRAWING	
Amount Due	Date Paid	Sheets Drwg.	Figs. Drwg.
		Print Fig.	
<input type="checkbox"/> TERMINAL DISCLAIMER		Application Examiner	
		PREPARED FOR ISSUE	
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